



# FCP380N60 / FCPF380N60

## N-Channel SuperFET® II MOSFET

### 600 V, 10.2 A, 380 mΩ

#### Features

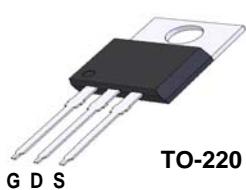
- 650 V @  $T_J = 150^\circ\text{C}$
- Max.  $R_{DS(on)} = 380 \text{ m}\Omega$
- Ultra low gate charge (typ.  $Q_g = 30 \text{ nC}$ )
- Low effective output capacitance (typ.  $C_{oss,eff} = 95 \text{ pF}$ )
- 100% avalanche tested

#### Applications

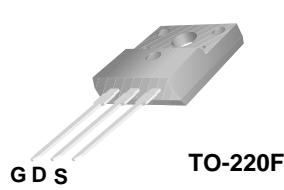
- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

#### Description

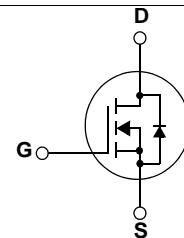
SuperFET® II MOSFET is Fairchild Semiconductor®'s first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFETII MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.



TO-220



TO-220F



#### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol         | Parameter  |   | FCP380N60                            | FCPF380N60 | Unit                      |
|----------------|--|---|--------------------------------------|------------|---------------------------|
| $V_{DSS}$      | Drain to Source Voltage  |   | 600                                  |            | V                         |
| $V_{GSS}$      | Gate to Source Voltage   | -DC                                       |                                      | $\pm 20$   | V                         |
|                |  | -AC ( $f > 1 \text{ Hz}$ )                |                                      | $\pm 30$   |                           |
| $I_D$          | Drain Current  | -Continuous ( $T_C = 25^\circ\text{C}$ )  | 10.2                                 | 10.2*      | A                         |
|                |  | -Continuous ( $T_C = 100^\circ\text{C}$ ) | 6.4                                  | 6.4*       |                           |
| $I_{DM}$       | Drain Current  | - Pulsed (Note 1)                         | 30.6                                 | 30.6*      | A                         |
| $E_{AS}$       | Single Pulsed Avalanche Energy (Note 2)                                      |   | 211.6                                |            | mJ                        |
| $I_{AR}$       | Avalanche Current (Note 1)   |   | 2.3                                  |            | A                         |
| $E_{AR}$       | Repetitive Avalanche Energy (Note 1)   |   | 1.06                                 |            | mJ                        |
| $dv/dt$        | Peak Diode Recovery $dv/dt$ (Note 3)   |   | 20                                   |            | V/ns                      |
|                | MOSFET $dv/dt$   |   | 100                                  |            |                           |
| $P_D$          | Power Dissipation ( $T_C = 25^\circ\text{C}$ )                               |   | 106                                  | 31         | W                         |
|                |  | - Derate above $25^\circ\text{C}$         | 0.85                                 | 0.25       | $\text{W}/^\circ\text{C}$ |
| $T_J, T_{STG}$ | Operating and Storage Temperature Range                                      |   | $-55 \text{ to } +150^\circ\text{C}$ |            | $^\circ\text{C}$          |
| $T_L$          | Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds |   | 300                                  |            | $^\circ\text{C}$          |

\*Drain current limited by maximum junction temperature

#### Thermal Characteristics

| Symbol          | Parameter                                       | FCP380N60 | FCPF380N60 | Unit                      |
|-----------------|---|-----------|------------|---------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case            | 1.18      | 4          | $^\circ\text{C}/\text{W}$ |
| $R_{\theta CS}$ | Thermal Resistance, Case to Heat Sink (Typical) | 0.5       | 0.5        |                           |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient         | 62.5      | 62.5       |                           |

## Package Marking and Ordering Information

| Device Marking | Device     | Package | Reel Size | Tape Width | Quantity |
|----------------|------------|---------|-----------|------------|----------|
| FCP380N60      | FCP380N60  | TO-220  | -         | -          | 50       |
| FCPF380N60     | FCPF380N60 | TO-220F | -         | -          | 50       |

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------|-----------|-----------------|------|------|------|------|
|--------|-----------|-----------------|------|------|------|------|

### Off Characteristics

|  |   |  |     |     |           |                           |
|--|---|--|-----|-----|-----------|---------------------------|
| $\text{BV}_{\text{DSS}}$                   | Drain to Source Breakdown Voltage         | $V_{\text{GS}} = 0 \text{ V}, I_D = 10 \text{ mA}, T_J = 25^\circ\text{C}$ | 600 | -   | -         | V                         |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D = 10 \text{ mA}$ , Referenced to $25^\circ\text{C}$                   | -   | 0.6 | -         | $\text{V}/^\circ\text{C}$ |
| $\text{BV}_{\text{DS}}$                    | Drain-Source Avalanche Breakdown Voltage  | $V_{\text{GS}} = 0 \text{ V}, I_D = 10 \text{ A}$                          | -   | 700 | -         | V                         |
| $I_{\text{DSS}}$                           | Zero Gate Voltage Drain Current           | $V_{\text{DS}} = 480 \text{ V}, V_{\text{GS}} = 0 \text{ V}$               | -   | -   | 1         | $\mu\text{A}$             |
| $I_{\text{GSS}}$                           | Gate to Body Leakage Current              | $V_{\text{GS}} = \pm 20 \text{ V}, V_{\text{DS}} = 0 \text{ V}$            | -   | -   | $\pm 100$ | nA                        |

### On Characteristics

|                     |                                      |  |     |      |      |          |
|---------------------|--------------------------------------|--|-----|------|------|----------|
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage               | $V_{\text{GS}} = V_{\text{DS}}, I_D = 250 \mu\text{A}$ | 2.5 | -    | 3.5  | V        |
| $R_{\text{DS(on)}}$ | Static Drain to Source On Resistance | $V_{\text{GS}} = 10 \text{ V}, I_D = 5 \text{ A}$      | -   | 0.33 | 0.38 | $\Omega$ |
| $g_{\text{FS}}$     | Forward Transconductance             | $V_{\text{DS}} = 20 \text{ V}, I_D = 5 \text{ A}$      | -   | 11   | -    | S        |

### Dynamic Characteristics

|                       |                               |  |          |      |      |          |
|-----------------------|-------------------------------|--|----------|------|------|----------|
| $C_{\text{iss}}$      | Input Capacitance             | $V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}$<br>$f = 1 \text{ MHz}$   | -        | 1250 | 1665 | pF       |
| $C_{\text{oss}}$      | Output Capacitance            |  | -        | 905  | 1205 | pF       |
| $C_{\text{rss}}$      | Reverse Transfer Capacitance  |  | -        | 45   | 60   | pF       |
| $C_{\text{oss}}$      | Output Capacitance            | $V_{\text{DS}} = 380 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$    | -        | 23   | -    | pF       |
| $C_{\text{oss eff.}}$ | Effective Output Capacitance  | $V_{\text{DS}} = 0 \text{ V} \text{ to } 480 \text{ V}, V_{\text{GS}} = 0 \text{ V}$ | -        | 95   | -    | pF       |
| $Q_{\text{g(tot)}}$   | Total Gate Charge at 10V      | $V_{\text{DS}} = 380 \text{ V}, I_D = 5 \text{ A}$                                   | -        | 30   | 40   | nC       |
| $Q_{\text{gs}}$       | Gate to Source Gate Charge    | $V_{\text{GS}} = 10 \text{ V}$   | (Note 4) | 5    | -    | nC       |
| $Q_{\text{gd}}$       | Gate to Drain "Miller" Charge |  |          | 10   | -    | nC       |
| ESR                   | Equivalent Series Resistance  | Drain Open   |          | 1    |      | $\Omega$ |

### Switching Characteristics

|                     |                     |  |          |    |     |    |
|---------------------|---------------------|--|----------|----|-----|----|
| $t_{\text{d(on)}}$  | Turn-On Delay Time  | $V_{\text{DD}} = 380 \text{ V}, I_D = 5 \text{ A}$<br>$V_{\text{GS}} = 10 \text{ V}, R = 4.7 \Omega$ | -        | 14 | 38  | ns |
| $t_f$               | Turn-On Rise Time   |  | -        | 7  | 24  | ns |
| $t_{\text{d(off)}}$ | Turn-Off Delay Time |  | -        | 45 | 100 | ns |
| $t_f$               | Turn-Off Fall Time  |  | (Note 4) | -  | 6   | 22 |

### Drain-Source Diode Characteristics

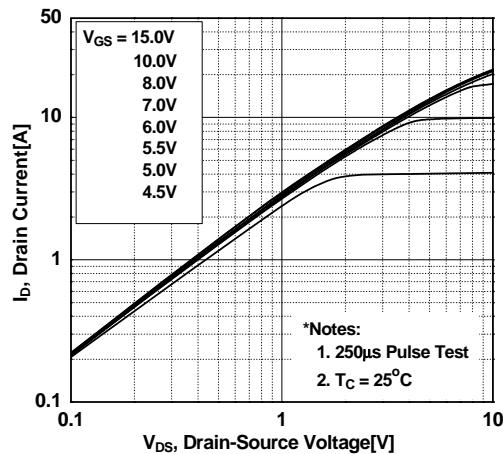
|                 |  |  |   |      |     |               |
|-----------------|--|--|---|------|-----|---------------|
| $I_S$           | Maximum Continuous Drain to Source Diode Forward Current | -  | - | 10.2 | A   |               |
| $I_{\text{SM}}$ | Maximum Pulsed Drain to Source Diode Forward Current     | -  | - | 30.6 | A   |               |
| $V_{\text{SD}}$ | Drain to Source Diode Forward Voltage                    | $V_{\text{GS}} = 0 \text{ V}, I_{\text{SD}} = 5 \text{ A}$ | - | -    | 1.2 | V             |
| $t_{\text{rr}}$ | Reverse Recovery Time                                    | $V_{\text{GS}} = 0 \text{ V}, I_{\text{SD}} = 5 \text{ A}$ | - | 240  | -   | ns            |
| $Q_{\text{rr}}$ | Reverse Recovery Charge                                  | $dI_F/dt = 100 \text{ A}/\mu\text{s}$                      | - | 2.7  | -   | $\mu\text{C}$ |

#### Notes:

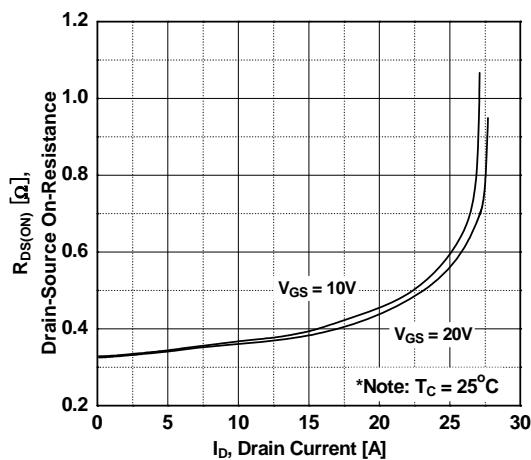
1. Repetitive Rating: Pulse width limited by maximum junction temperature
2.  $I_{\text{AS}} = 2.3 \text{ A}, V_{\text{DD}} = 50 \text{ V}, R_G = 25 \Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{\text{SD}} \leq 5.1 \text{ A}, di/dt \leq 200 \text{ A}/\mu\text{s}, V_{\text{DD}} \leq BV_{\text{DSS}}$ , Starting  $T_J = 25^\circ\text{C}$
4. Essentially Independent of Operating Temperature Typical Characteristics

## Typical Performance Characteristics

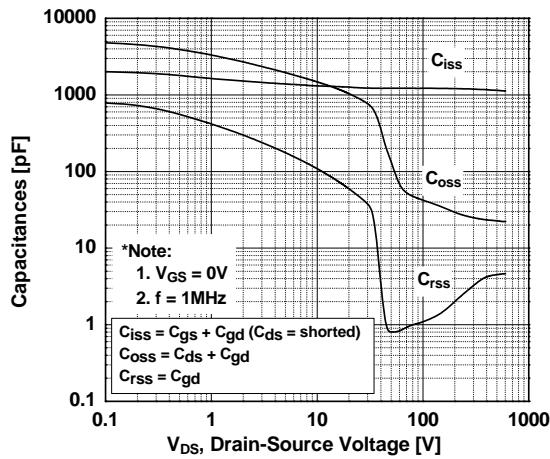
**Figure 1. On-Region Characteristics**



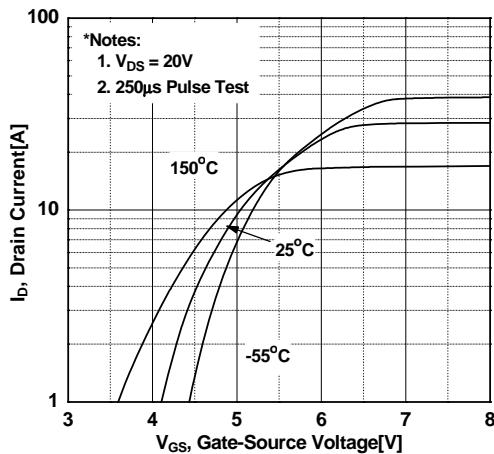
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



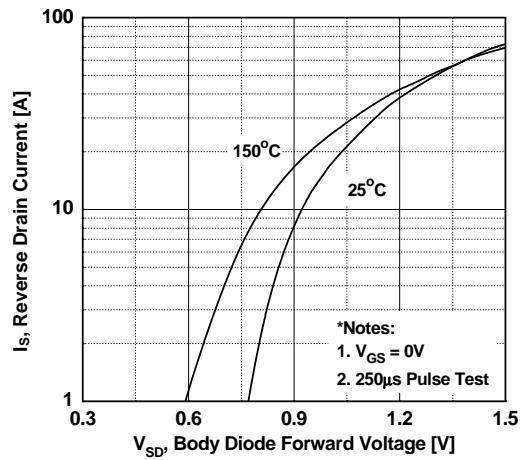
**Figure 5. Capacitance Characteristics**



**Figure 2. Transfer Characteristics**



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**



**Figure 6. Gate Charge Characteristics**

